



# 1K x 8 Dual-Port Static RAM

### **Features**

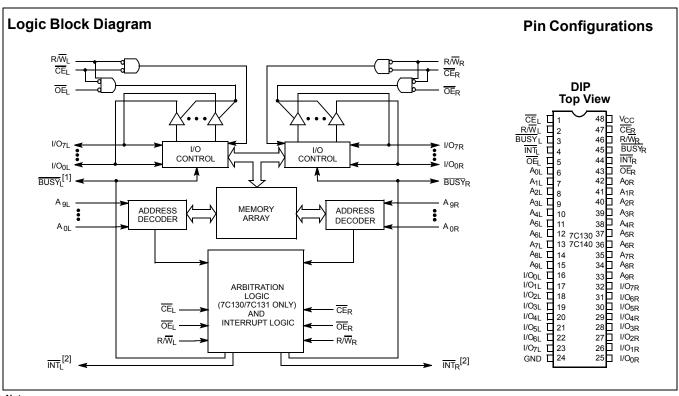
- True Dual-Ported memory cells which allow simultaneous reads of the same memory location
- 1K x 8 organization
- 0.65-micron CMOS for optimum speed/power
- · High-speed access: 15 ns
- Low operating power: I<sub>CC</sub> = 110 mA (max.)
- Fully asynchronous operation
- · Automatic power-down
- Master CY7C130/CY7C131 easily expands data bus width to 16 or more bits using slave CY7C140/CY7C141
- BUSY output flag on CY7C130/CY7C131; BUSY input on CY7C140/CY7C141
- · INT flag for port-to-port communication
- Available in 48-pin DIP (CY7C130/140), 52-pin PLCC, 52-Pin TQFP.
- · Pb-Free packages available

### **Functional Description**

The CY7C130/CY7C131/CY7C140 and CY7C141 are high-speed CMOS 1K by 8 dual-port static RAMs. Two ports are provided permitting independent access to any location in memory. The CY7C130/ CY7C131 can be utilized as either a standalone 8-bit dual-port static RAM or as a master dual-port RAM in conjunction with the CY7C140/CY7C141 slave dual-port device in systems requiring 16-bit or greater word widths. It is the solution to applications requiring shared or buffered data, such as cache memory for DSP, bit-slice, or multiprocessor designs.

Each port has independent control pins; chip enable  $(\overline{CE})$ , write enable (R/W), and output enable  $(\overline{OE})$ . Two flags are provided on each port, BUSY and INT. BUSY signals that the port is trying to access the same location currently being accessed by the other port.  $\overline{INT}$  is an interrupt flag indicating that data has been placed in a unique location (3FF for the left port and 3FE for the right port). An automatic power-down feature is controlled independently on each port by the chip enable  $(\overline{CE})$  pins.

The CY7C130 and CY7C140 are available in 48-pin DIP. The CY7C131 and CY7C141 are available in 52-pin PLCC, 52-pin Pb-free PLCC, 52-pin PQFP and 52-pin Pb-free PQFP.

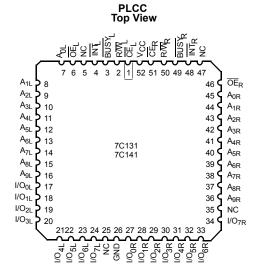


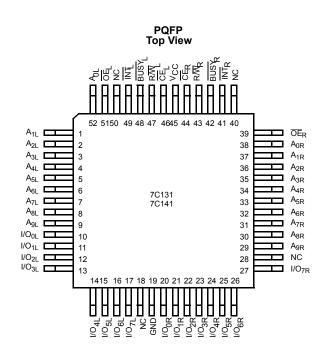
### Note

- CY7C130/CY7C131 (Master): <u>BUSY</u> is open drain output and requires pull-up resistor CY7C140/CY7C141 (Slave): BUSY is input.
- 2. Open drain outputs: pull-up resistor required.



# Pin Configuration (continued)





### **Pin Definitions**

Left Port	Right Port	Description
CEL	CE <sub>R</sub>	Chip Enable
$R/\overline{W}_L$	R/W <sub>R</sub>	Read/Write Enable
ŌĒL	ŌĒ <sub>R</sub>	Output Enable
A <sub>0L</sub> -A <sub>11/12L</sub>	A <sub>0R</sub> -A <sub>11/12R</sub>	Address
I/O <sub>0L</sub> –I/O <sub>15/17L</sub>	I/O <sub>0R</sub> -I/O <sub>15/17R</sub>	Data Bus Input/Output
ĪNT <sub>L</sub>	ĪNT <sub>R</sub>	Interrupt Flag
BUSYL	BUSY <sub>R</sub>	Busy Flag
V <sub>CC</sub>		Power
GND		Ground

### **Selection Guide**

		7C131-15 <sup>[3]</sup> 7C141-15	7C131-25 <sup>[3]</sup> 7C141-25	7C130-30 7C131-30 7C140-30 7C141-30	7C130-35 7C131-35 7C140-35 7C141-35	7C130-45 7C131-45 7C140-45 7C141-45	7C130-55 7C131-55 7C140-55 7C141-55	Unit
Maximum Access Time		15	25	30	35	45	55	ns
Maximum Operating	Com'l/Ind	190	170	170	120	120	110	mA
Current	Military				170	170	120	
Maximum Standby	Com'l/Ind	75	65	65	45	45	35	mA
Current	Military				65	65	45	

Shaded areas contain preliminary information.

### Note

3. 15 and 25-ns version available only in PLCC/PQFP packages.



### Maximum Ratings<sup>[4]</sup>

Static Discharge Voltage	. >2001V
(per MIL-STD-883, Method 3015)	
Latch-Up Current	>200 mA

### **Operating Range**

Range	Ambient Temperature	V <sub>cc</sub>
Commercial	0°C to +70°C	5V ± 10%
Industrial	–40°C to +85°C	5V ± 10%
Military <sup>[5]</sup>	–55°C to +125°C	5V ± 10%

### Electrical Characteristics Over the Operating Range<sup>[6]</sup>

					1-15 <sup>[3]</sup> 41-15	7C131 7C14	0-30 <sup>[3]</sup> I-25,30 40-30 I-25,30	7C13	0-35,45 1-35,45 0-35,45 1-35,45	7C13	30-55 31-55 40-55 41-55	
Parameter	Description	Test Condition	ns	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min., I <sub>OH</sub> = -	4.0 mA	2.4		2.4		2.4		2.4		V
V <sub>OL</sub>	Output LOW	I <sub>OL</sub> = 4.0 mA			0.4		0.4		0.4		0.4	V
	Voltage	I <sub>OL</sub> = 16.0 mA <sup>[7]</sup>			0.5		0.5		0.5		0.5	
V <sub>IH</sub>	Input HIGH Voltage			2.2		2.2		2.2		2.2		V
V <sub>IL</sub>	Input LOW Voltage				0.8		0.8		0.8		0.8	V
I <sub>IX</sub>	Input Leakage Current	$GND \leq V_I \leq V_CC$		<b>–</b> 5	+5	<b>–</b> 5	+5	-5	+5	<b>–</b> 5	+5	μА
I <sub>OZ</sub>	Output Leakage Current	$\begin{array}{l} \text{GND} \leq \text{V}_{\text{O}} \leq \text{V}_{\text{CC}}, \\ \text{Output Disabled} \end{array}$		<b>–</b> 5	+5	<b>–</b> 5	+5	<b>-</b> 5	+5	<b>-</b> 5	+5	μА
I <sub>OS</sub>	Output Short Circuit Current <sup>[8, 9]</sup>	V <sub>CC</sub> = Max., V <sub>OUT</sub> = GND			-350		-350		-350		-350	mA
I <sub>CC</sub>	V <sub>CC</sub> Operating	CE = V <sub>IL</sub> ,	Com'l		190		170		120		110	mA
	Supply Current	Outputs Open, f = f <sub>MAX</sub> <sup>[10]</sup>	Mil						170		120	•
I <sub>SB1</sub>	Standby Current	CE <sub>L</sub> and CE <sub>R</sub> > V <sub>IH</sub> , f = f <sub>MAX</sub> [10]	Com'l		75		65		45		35	mA
	Both Ports, TTL Inputs	$V_{IH}$ , $f = f_{MAX}^{[10]}$	Mil						65		45	
I <sub>SB2</sub>	Standby Current	$\overline{CE}_L$ or $\overline{CE}_R \ge V_{IH}$ ,	Com'l		135		115		90		75	mA
	One Port, TTL Inputs	Active Port Outputs Open, f = f <sub>MAX</sub> <sup>[10]</sup>	Mil						115		90	
I <sub>SB3</sub>	Standby Current	Both Ports CE <sub>L</sub> and	Com'l		15		15		15		15	mA
	Both Ports, CMOS Inputs	$CE_R \ge V_{CC} - 0.2V,$ $V_{IN} \ge V_{CC} - 0.2V$ or $V_{IN} \le 0.2V, f = 0$	Mil						15		15	

Shaded areas contain preliminary information.

### Note:

- 4. The Voltage on any input or I/O pin cannot exceed the power pin during power-up.
- 5. T<sub>A</sub> is the "instant on" case temperature
- 6. See the last page of this specification for Group A subgroup testing information.
- BUSY and INT pins only.
- 8. Duration of the short circuit should not exceed 30 seconds.
- 9. This parameter is guaranteed but not tested.
- 10. At f = f<sub>MAX</sub>, address and data inputs are cycling at the maximum frequency of read cycle of 1/t<sub>RC</sub> and using AC Test Waveforms input levels of GND to 3V.



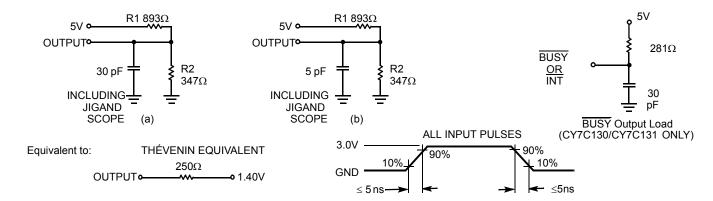
### Electrical Characteristics Over the Operating Range<sup>[6]</sup> (continued)

					1-15 <sup>[3]</sup> I1-15	7C130-30 <sup>[3]</sup> 7C131-25,30 7C140-30 7C141-25,30		7C130-35,45 7C131-35,45 7C140-35,45 7C141-35,45		7C131-55 7C140-55		
Parameter	Description	Test Condition	ns	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
I <sub>SB4</sub>	Standby Current	One Port CE <sub>L</sub> or	Com'l		125		105		85		70	mA
	One Port, CMOS Inputs	$\begin{split} & \text{CE}_{\text{R}} \geq \text{V}_{\text{CC}} - 0.2\text{V}, \\ & \text{V}_{\text{IN}} \geq \text{V}_{\text{CC}} - 0.2\text{V} \\ & \text{or V}_{\text{IN}} \leq 0.2\text{V}, \\ & \text{Active Port Outputs} \\ & \text{Open}, \\ & \text{f} = f_{\text{MAX}}^{[10]} \end{split}$	Mil						105		85	

# Capacitance<sup>[9]</sup>

Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	15	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 5.0V$	10	pF

### **AC Test Loads and Waveforms**



[+] Feedback



# Switching Characteristics Over the Operating Range<sup>[6, 11]</sup>

			1-15 <sup>[3]</sup> 41-15	7C1: 7C1	0-25 <sup>[3]</sup> 31-25 40-25 41-25	7C1: 7C1	30-30 31-30 40-30 41-30	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYCL	Ē	·						
t <sub>RC</sub>	Read Cycle Time	15		25		30		ns
t <sub>AA</sub>	Address to Data Valid <sup>[12]</sup>		15		25		30	ns
t <sub>OHA</sub>	Data Hold from Address Change	0		0		0		ns
t <sub>ACE</sub>	CE LOW to Data Valid <sup>[12]</sup>		15		25		30	ns
t <sub>DOE</sub>	OE LOW to Data Valid <sup>[12]</sup>		10		15		20	ns
t <sub>LZOE</sub>	OE LOW to Low Z <sup>[9, 13, 14]</sup>	3		3		3		ns
t <sub>HZOE</sub>	OE HIGH to High Z <sup>[9, 13, 14]</sup>		10		15		15	ns
t <sub>LZCE</sub>	CE LOW to Low Z <sup>[9, 13, 14]</sup>	3		5		5		ns
t <sub>HZCE</sub>	CE HIGH to High Z <sup>[9, 13, 14]</sup>		10		15		15	ns
t <sub>PU</sub>	CE LOW to Power-Up <sup>[9]</sup>	0		0		0		ns
t <sub>PD</sub>	CE HIGH to Power-Down <sup>[9]</sup>		15		25		25	ns
WRITE CYC	LE <sup>[15]</sup>	<u>'</u>	I	1				.1
t <sub>WC</sub>	Write Cycle Time	15		25		30		ns
t <sub>SCE</sub>	CE LOW to Write End	12		20		25		ns
t <sub>AW</sub>	Address Set-Up to Write End	12		20		25		ns
t <sub>HA</sub>	Address Hold from Write End	2		2		2		ns
t <sub>SA</sub>	Address Set-Up to Write Start	0		0		0		ns
t <sub>PWE</sub>	R/W Pulse Width	12		15		25		ns
t <sub>SD</sub>	Data Set-Up to Write End	10		15		15		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		ns
t <sub>HZWE</sub>	R/W LOW to High Z <sup>[14]</sup>		10		15		15	ns
t <sub>LZWE</sub>	R/W HIGH to Low Z <sup>[14]</sup>	0		0		0		ns
	ntain preliminary information.			1	1	1	1	

Shaded areas contain preliminary information.

<sup>11.</sup> Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading of the specified I<sub>OL</sub>/I<sub>OH,</sub> and 30-pF load capacitance.

12. AC Test Conditions use V<sub>OH</sub> = 1.6V and V<sub>OL</sub> = 1.4V.

<sup>12.</sup> AC lest Conditions use V<sub>OH</sub> = 1.6V and V<sub>OL</sub> = 1.4V.

13. At any given temperature and voltage condition for any given device, t<sub>HZCE</sub> is less than t<sub>LZCE</sub> and t<sub>HZOE</sub> is less than t<sub>LZOE</sub>.

14. t<sub>LZCE</sub>, t<sub>LZWE</sub>, t<sub>HZOE</sub>, t<sub>HZOE</sub>, t<sub>HZCE</sub> and t<sub>HZWE</sub> are tested with C<sub>L</sub> = 5<u>pF</u> as in part (b) <u>of</u> AC Test Loads. Transition is measured ±500 mV from steady state voltage.

15. The internal write time of the memory is defined by the overlap of CS LOW and R/W LOW. Both signals must be low to initiate a write and either signal can terminate a write by going high. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.



# Switching Characteristics Over the Operating Range $^{[6,\ 11]}$ (continued)

			1-15 <sup>[3]</sup> 41-15	7C1: 7C1	0-25 <sup>[3]</sup> 31-25 40-25 41-25	7C1: 7C1:	30-30 31-30 40-30 41-30	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
BUSY/INTER	RUPT TIMING							
t <sub>BLA</sub>	BUSY LOW from Address Match		15		20		20	ns
t <sub>BHA</sub>	BUSY HIGH from Address Mismatch <sup>[16]</sup>		15		20		20	ns
t <sub>BLC</sub>	BUSY LOW from CE LOW		15		20		20	ns
t <sub>BHC</sub>	BUSY HIGH from CE HIGH <sup>[16]</sup>		15		20		20	ns
t <sub>PS</sub>	Port Set Up for Priority	5		5		5		ns
t <sub>WB</sub> <sup>[17]</sup>	R/W LOW after BUSY LOW	0		0		0		ns
t <sub>WH</sub>	R/W HIGH after BUSY HIGH	13		20		30		ns
t <sub>BDD</sub>	BUSY HIGH to Valid Data		15		25		30	ns
t <sub>DDD</sub>	Write Data Valid to Read Data Valid		Note 18		Note 18		Note 18	ns
t <sub>WDD</sub>	Write Pulse to Data Delay		Note 18		Note 18		Note 18	ns
INTERRUPT	TIMING							
t <sub>WINS</sub>	R/W to INTERRUPT Set Time		15		25		25	ns
t <sub>EINS</sub>	CE to INTERRUPT Set Time		15		25		25	ns
t <sub>INS</sub>	Address to INTERRUPT Set Time		15		25		25	ns
t <sub>OINR</sub>	OE to INTERRUPT Reset Time <sup>[16]</sup>		15		25		25	ns
t <sub>EINR</sub>	CE to INTERRUPT Reset Time <sup>[16]</sup>		15		25		25	ns
t <sub>INR</sub>	Address to INTERRUPT Reset Time <sup>[16]</sup>		15		25		25	ns

Shaded areas contain preliminary information.

## Switching Characteristics Over the Operating Range<sup>[6,11]</sup>

		7C130-35 7C131-35 7C140-35 7C141-35		7C130-45 7C131-45 7C140-45 7C141-45		7C130-55 7C131-55 7C140-55 7C141-55		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYCL	Ē	·						
t <sub>RC</sub>	Read Cycle Time	35		45		55		ns
t <sub>AA</sub>	Address to Data Valid <sup>[12]</sup>		35		45		55	ns
t <sub>OHA</sub>	Data Hold from Address Change	0		0		0		ns
t <sub>ACE</sub>	CE LOW to Data Valid <sup>[12]</sup>		35		45		55	ns
t <sub>DOE</sub>	OE LOW to Data Valid <sup>[12]</sup>		20		25		25	ns
t <sub>LZOE</sub>	OE LOW to Low Z <sup>[9, 13, 14]</sup>	3		3		3		ns
t <sub>HZOE</sub>	OE HIGH to High Z <sup>[9, 13, 14]</sup>		20		20		25	ns
t <sub>LZCE</sub>	CE LOW to Low Z <sup>[9, 13, 14]</sup>	5		5		5		ns

<sup>16.</sup> These parameters are measured from the input signal changing, until the output pin goes to a high-impedance state.

<sup>17.</sup> CY7C140/CY7C141 only.

<sup>18. &</sup>lt;u>A write</u> operation on Port A, where Port A has priority, leaves the data on Port B's outputs undisturbed until one access time after one of the following: BUSY on Port B goes HIGH.

<u>Port B's address is toggled.</u>

<u>CE for Port B is toggled.</u>

R/W for Port B is toggled during valid read.



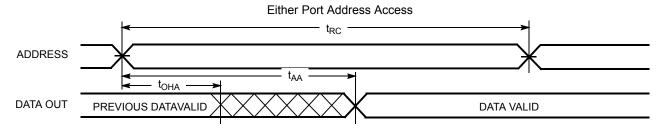
# $\textbf{Switching Characteristics} \ \, \text{Over the Operating Range}^{[6,11]} \ \, \text{(continued)}$

		7C13	30-35 31-35 40-35 41-35	7C13 7C13 7C14 7C14	1-45 0-45	7C13	30-55 31-55 40-55 41-55	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t <sub>HZCE</sub>	CE HIGH to High Z <sup>[9, 13, 14]</sup>		20		20		25	ns
t <sub>PU</sub>	CE LOW to Power-Up <sup>[9]</sup>	0		0		0		ns
t <sub>PD</sub>	CE HIGH to Power-Down <sup>[9]</sup>		35		35		35	ns
WRITE CYC	L <b>E</b> <sup>[15]</sup>							
t <sub>WC</sub>	Write Cycle Time	35		45		55		ns
t <sub>SCE</sub>	CE LOW to Write End	30		35		40		ns
t <sub>AW</sub>	Address Set-Up to Write End	30		35		40		ns
t <sub>HA</sub>	Address Hold from Write End	2		2		2		ns
t <sub>SA</sub>	Address Set-Up to Write Start	0		0		0		ns
t <sub>PWE</sub>	R/W Pulse Width	25		30		30		ns
t <sub>SD</sub>	Data Set-Up to Write End	15		20		20		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		ns
t <sub>HZWE</sub>	$R/\overline{W}$ LOW to High $Z^{[14]}$		20		20		25	ns
t <sub>LZWE</sub>	$R/\overline{W}$ HIGH to Low $Z^{[14]}$	0		0		0		ns
BUSY/INTER	RRUPT TIMING							
t <sub>BLA</sub>	BUSY LOW from Address Match		20		25		30	ns
t <sub>BHA</sub>	BUSY HIGH from Address Mismatch <sup>[16]</sup>		20		25		30	ns
t <sub>BLC</sub>	BUSY LOW from CE LOW		20		25		30	ns
t <sub>BHC</sub>	BUSY HIGH from CE HIGH <sup>[16]</sup>		20		25		30	ns
t <sub>PS</sub>	Port Set Up for Priority	5		5		5		ns
t <sub>WB</sub> <sup>[17]</sup>	R/W LOW after BUSY LOW	0		0		0		ns
t <sub>WH</sub>	R/W HIGH after BUSY HIGH	30		35		35		ns
t <sub>BDD</sub>	BUSY HIGH to Valid Data		35		45		45	ns
t <sub>DDD</sub>	Write Data Valid to Read Data Valid		Note 18		Note 18		Note 18	ns
t <sub>WDD</sub>	Write Pulse to Data Delay		Note 18		Note 18		Note 18	ns
INTERRUPT	TIMING		<u>.</u>		1	1		1
t <sub>WINS</sub>	R/W to INTERRUPT Set Time		25		35		45	ns
t <sub>EINS</sub>	CE to INTERRUPT Set Time		25		35		45	ns
t <sub>INS</sub>	Address to INTERRUPT Set Time		25		35		45	ns
t <sub>OINR</sub>	OE to INTERRUPT Reset Time <sup>[16]</sup>		25		35		45	ns
t <sub>EINR</sub>	CE to INTERRUPT Reset Time <sup>[16]</sup>		25		35		45	ns
t <sub>INR</sub>	Address to INTERRUPT Reset Time <sup>[16]</sup>		25		35		45	ns

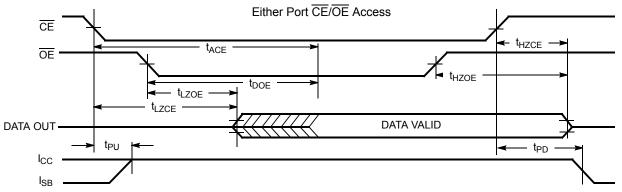


# **Switching Waveforms**

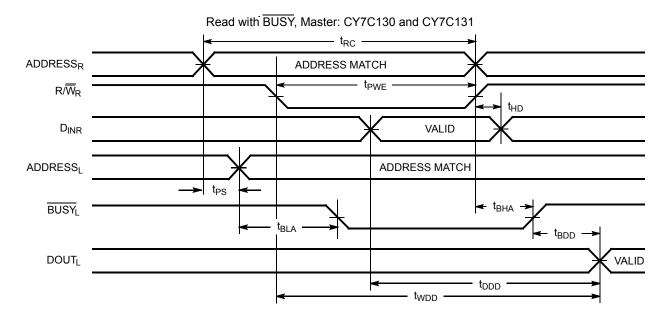
Read Cycle No. 1<sup>[19, 20]</sup>



# **Read Cycle No. 2**<sup>[19, 21]</sup>



Read Cycle No. 3<sup>[20]</sup>

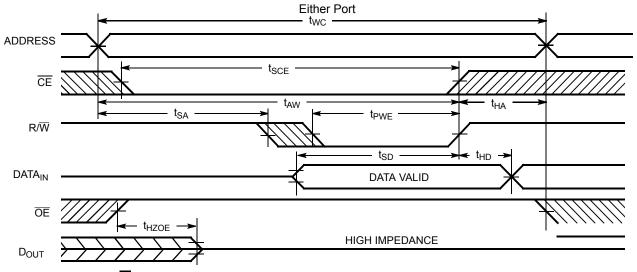


- 19. R/W is HIGH for read cycle.
- 20. Device is continuously selected,  $\overline{\text{CE}} = \text{V}_{\text{IL}}$  and  $\overline{\text{OE}} = \text{V}_{\text{IL}}$ . 21. Address valid prior to or coincident with  $\overline{\text{CE}}$  transition LOW.

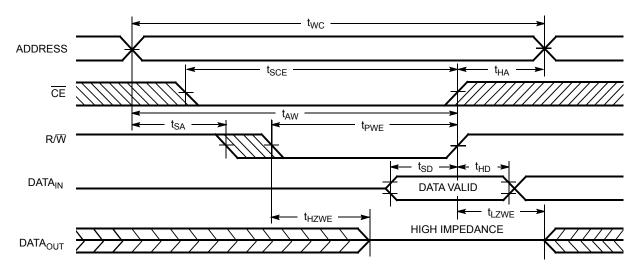
[+] Feedback



Write Cycle No. 1 (OE Three-States Data I/Os—Either Port[15, 22]



Write Cycle No. 2 (R/ $\overline{W}$  Three-States Data I/Os—Either Port)<sup>[16, 23]</sup>



Notes:

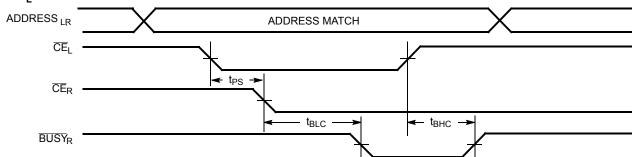
22. If  $\overline{OE}$  is LOW during a R/W controlled write cycle, the write pulse width must be the larger of  $t_{PWE}$  or  $t_{HZWE} + t_{SD}$  to allow the data I/O pins to enter high impedance and for data to be placed on the bus for the required  $t_{SD}$ .

23. If the  $\overline{CE}$  LOW transition occurs simultaneously with or after the R/W LOW transition, the outputs remain in the high-impedance state.

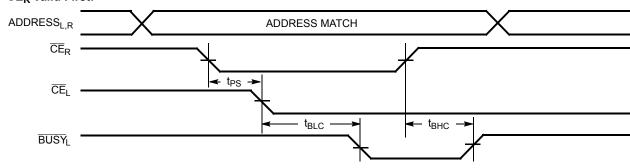


### **Busy Timing Diagram No. 1 (CE Arbitration)**

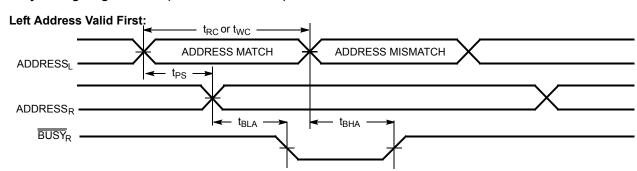
## **CE**<sub>L</sub> Valid First:

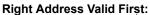


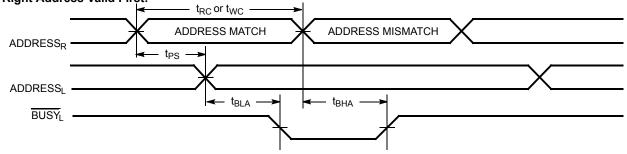
## CE<sub>R</sub> Valid First:



### **Busy Timing Diagram No. 2 (Address Arbitration)**



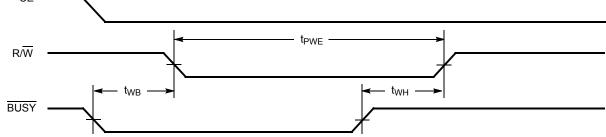






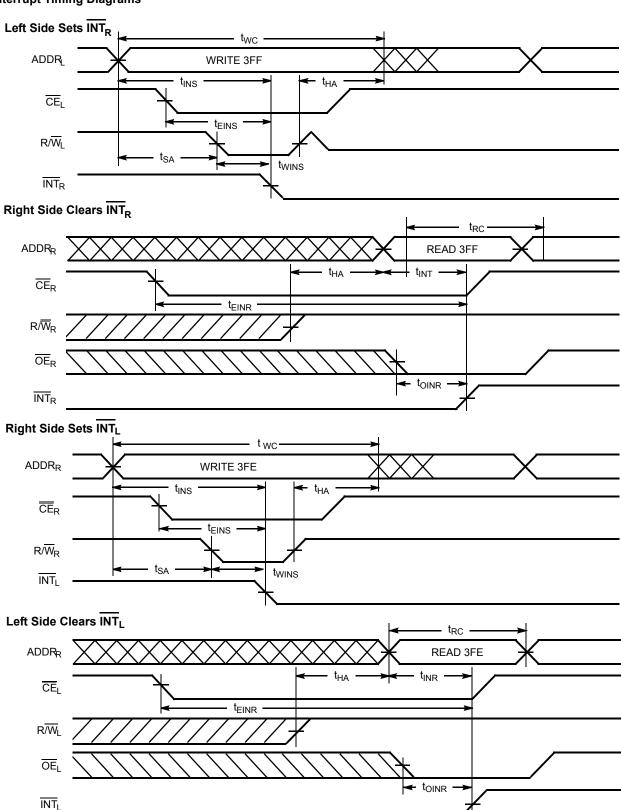
**Busy Timing Diagram No. 3** 

Write with BUSY (Slave:CY7C140/CY7C141)



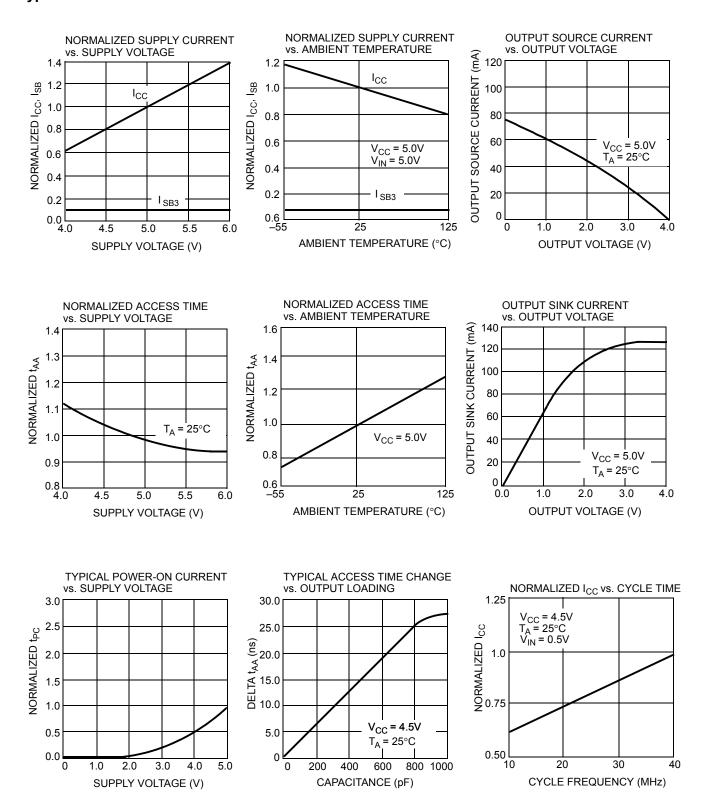


**Interrupt Timing Diagrams** 





## Typical DC and AC Characteristics





# **Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
30	CY7C130-30PC	P25	48-Lead (600-Mil) Molded DIP	Commercial
	CY7C130-30PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
35	CY7C130-35PC	P25	48-Lead (600-Mil) Molded DIP	Commercial
	CY7C130-35PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
	CY7C130-35DMB	D26	48-Lead (600-Mil) Sidebraze DIP	Military
45	CY7C130-45PC	P25	48-Lead (600-Mil) Molded DIP	Commercial
	CY7C130-45PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
	CY7C130-45DMB	D26	48-Lead (600-Mil) Sidebraze DIP	Military
55	CY7C130-55PC	P25	48-Lead (600-Mil) Molded DIP	Commercial
	CY7C130-55PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
	CY7C130-55DMB	D26	48-Lead (600-Mil) Sidebraze DIP	Military
15	CY7C131-15JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C131-15JXC	J69	52-Lead Pb-Free Plastic Leaded Chip Carrier	
	CY7C131-15NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C131-15JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C131-15JXI	J69	52-Lead Pb-Free Plastic Leaded Chip Carrier	
25	CY7C131-25JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C131-25JXC	J69	52-Lead Pb-Free Plastic Leaded Chip Carrier	
	CY7C131-25NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C131-25NXC	N52	52-Pin Pb-Free Plastic Quad Flatpack	
	CY7C131-25JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C131-25NI	N52	52-Pin Plastic Quad Flatpack	
30	CY7C131-30JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C131-30NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C131-30JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
35	CY7C131-35JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C131-35NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C131-35JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C131-35NI	N52	52-Pin Plastic Quad Flatpack	
45	CY7C131-45JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C131-45NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C131-45JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C131-45NI	N52	52-Pin Plastic Quad Flatpack	
55	CY7C131-55JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C131-55JXC	J69	52-Lead Pb-Free Plastic Leaded Chip Carrier	7
	CY7C131-55NC	N52	52-Pin Plastic Quad Flatpack	7
	CY7C131-55NXC	N52	52-Pin Pb-Free Plastic Quad Flatpack	1
	CY7C131-55JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C131-55JXI	J69	52-Lead Pb-Free Plastic Leaded Chip Carrier	1
	CY7C131-55NI	N52	52-Pin Plastic Quad Flatpack	7

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# Ordering Information (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
30	CY7C140-30PC	P25	48-Lead (600-Mil) Molded DIP	Commercial
	CY7C140-30PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
35	CY7C140-35PC	P25	48-Lead (600-Mil) Molded DIP	Commercial
	CY7C140-35PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
	CY7C140-35DMB	D26	48-Lead (600-Mil) Sidebraze DIP	Military
45	CY7C140-45PC P25	48-Lead (600-Mil) Molded DIP	Commercial	
	CY7C140-45PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
	CY7C140-45DMB	D26	48-Lead (600-Mil) Sidebraze DIP	Military
55	CY7C140-55PC	P25	48-Lead (600-Mil) Molded DIP	Commercial
	CY7C140-55PI	P25	48-Lead (600-Mil) Molded DIP	Industrial
	CY7C140-55DMB	D26	48-Lead (600-Mil) Sidebraze DIP	Military
15	CY7C141-15JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C141-15NC	N52	52-Pin Plastic Quad Flatpack	
25	CY7C141-25JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C141-25JXC	J69	52-Lead Pb-Free Plastic Leaded Chip Carrier	
	CY7C141-25NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C141-25JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C141-25NI	N52	52-Pin Plastic Quad Flatpack	7
30	CY7C141-30JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C141-30NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C141-30JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
35	CY7C141-35JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C141-35NC	N52	52-Pin Plastic Quad Flatpack	7
	CY7C141-35JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C141-35NI	N52	52-Pin Plastic Quad Flatpack	7
45	CY7C141-45JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C141-45NC	N52	52-Pin Plastic Quad Flatpack	7
	CY7C141-45JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C141-45NI	N52	52-Pin Plastic Quad Flatpack	
55	CY7C141-55JC	J69	52-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C141-55NC	N52	52-Pin Plastic Quad Flatpack	
	CY7C141-55JI	J69	52-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C141-55NI	N52	52-Pin Plastic Quad Flatpack	



## **MILITARY SPECIFICATIONS**

# **Group A Subgroup Testing**

### **DC Characteristics**

Parameter	Subgroups
V <sub>OH</sub>	1, 2, 3
V <sub>OL</sub>	1, 2, 3
V <sub>IH</sub>	1, 2, 3
V <sub>IL</sub> Max.	1, 2, 3
I <sub>IX</sub>	1, 2, 3
I <sub>OZ</sub>	1, 2, 3
I <sub>CC</sub>	1, 2, 3
I <sub>SB1</sub>	1, 2, 3
I <sub>SB2</sub>	1, 2, 3
I <sub>SB3</sub>	1, 2, 3
I <sub>SB4</sub>	1, 2, 3

# **Switching Characteristics**

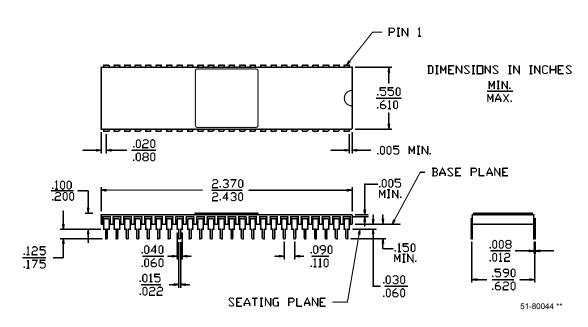
Parameter	Subgroups			
READ CYCLE				
t <sub>RC</sub>	7, 8, 9, 10, 11			
t <sub>AA</sub>	7, 8, 9, 10, 11			
t <sub>ACE</sub>	7, 8, 9, 10, 11			
t <sub>DOE</sub>	7, 8, 9, 10, 11			
WRITE CYCLE				
$t_{WC}$	7, 8, 9, 10, 11			
t <sub>SCE</sub>	7, 8, 9, 10, 11			
t <sub>AW</sub>	7, 8, 9, 10, 11			
t <sub>HA</sub>	7, 8, 9, 10, 11			
t <sub>SA</sub>	7, 8, 9, 10, 11			
t <sub>PWE</sub>	7, 8, 9, 10, 11			
t <sub>SD</sub>	7, 8, 9, 10, 11			
t <sub>HD</sub>	7, 8, 9, 10, 11			
BUSY/INTERRUPT TIMING				
t <sub>BLA</sub>	7, 8, 9, 10, 11			
t <sub>BHA</sub>	7, 8, 9, 10, 11			
t <sub>BLC</sub>	7, 8, 9, 10, 11			
t <sub>BHC</sub>	7, 8, 9, 10, 11			
t <sub>PS</sub>	7, 8, 9, 10, 11			
t <sub>WINS</sub>	7, 8, 9, 10, 11			
t <sub>EINS</sub>	7, 8, 9, 10, 11			
t <sub>INS</sub>	7, 8, 9, 10, 11			
t <sub>OINR</sub>	7, 8, 9, 10, 11			
t <sub>EINR</sub>	7, 8, 9, 10, 11			
t <sub>INR</sub>	7, 8, 9, 10, 11			
BUSY TIMING				
t <sub>WB</sub> <sup>[24]</sup>	7, 8, 9, 10, 11			
t <sub>WH</sub>	7, 8, 9, 10, 11			
t <sub>BDD</sub>	7, 8, 9, 10, 11			

**Note:** 24. CY7C140/CY7C141 only.

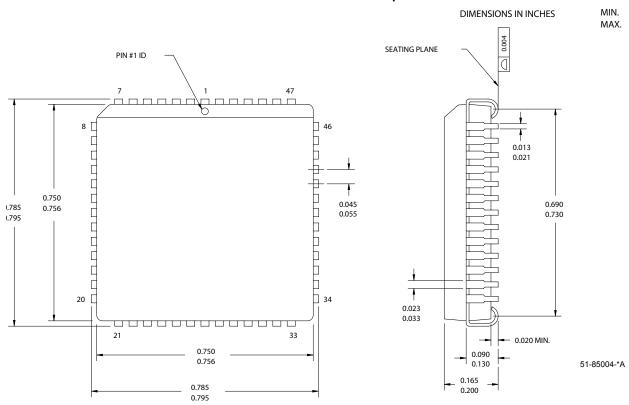


# **Package Diagrams**

# **48-Lead (600-Mil) Sidebraze DIP D26**MIL-STD-1835 D-14 Config. C



### 52-Lead Plastic Leaded Chip Carrier J69 52-Lead Pb-Free Plastic Leaded Chip Carrier J69

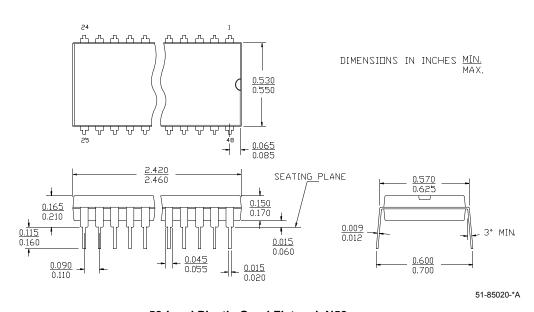


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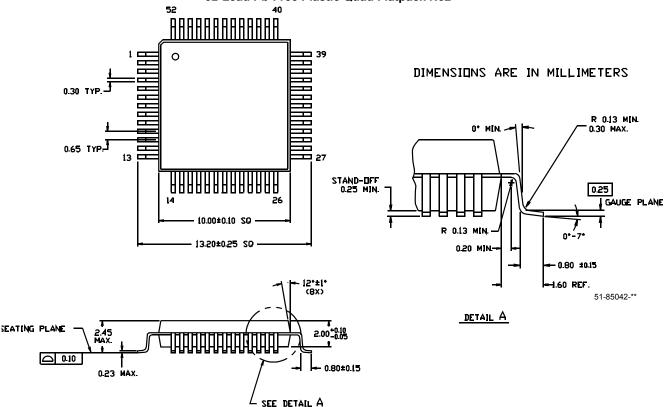


### Package Diagrams (continued)

### 48-Lead (600-Mil) Molded DIP P25



### 52-Lead Plastic Quad Flatpack N52 52-Lead Pb-Free Plastic Quad Flatpack N52



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# **Document History Page**

REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	110169	09/29/01	SZV	Change from Spec number: 38-00027 to 38-06002
*A	122255	12/26/02	RBI	Power up requirements added to Maximum Ratings Information
*B	236751	See ECN	YDT	Removed cross information from features section
*C	325936	See ECN	RUY	Added pin definitions table, 52-pin PQFP package diagram and Pb-free information
*D	393153	See ECN	YIM	Added CY7C131-15JI to ordering information Added Pb-Free parts to ordering information: CY7C131-15JXI